



H/H/Arnold  
a  
M. Wall  
12/19/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Douglas O. Powell  
Serial No.: 09/665,366  
Filed: September 19, 2000  
For: ELECTRONIC INTERCONNECT  
STRUCTURE AND METHOD FOR  
MAKING

: Art Unit: 3726

: Examiner: Compton, Eric B.

: Atty Docket: EN9-99-026  
(20135/00276)

RESPONSE AND AMENDMENT UNDER 37 CFR § 1.111

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

In response to the Office Action dated September 17, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Kindly amend the claims as follows:

1. A method for making a multi-layer electronic structure, the method comprising:  
providing a plurality of sub-composites, wherein each said sub-composite is formed by  
the steps of  
    providing a layer of dielectric material having a first surface and a second surface,  
    wherein said first surface is selected from the group consisting of a top surface and a  
    bottom surface,  
    providing a layer of electrically conducting material on said first surface;

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